

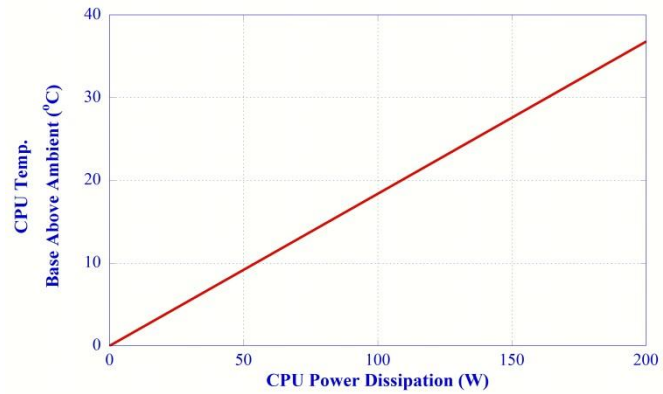
4 pipe and H.D.T. Core



High Density AL Fin

## Product Specification

<b>Application Socket</b>	Intel LGA 2011(Square Type)
<b>Cooler Dimension</b>	90mm X 88mm X 64mm
<b>Heat Sink Material</b>	Heatpipe + AL Fin +AL Base
<b>Fan Dimension</b>	60X60X25
<b>Bearing Type</b>	2ball Bearing Fan Life Expectancy at 25°C 50000HR
<b>Fan Speed (RPM)</b>	2000~6500
<b>Fan Airflow (CFM)</b>	31.97 Max
<b>Static Pressure (inchH2O)</b>	0.4Max
<b>Fan Noise Level (dBA)</b>	<41
<b>Rated Voltage (V)</b>	12
<b>Weight (g)</b>	324
<b>Application System</b>	2U Form Factor Active Solution
<b>CPU Support</b>	Intel® Sandy Bridge Romley-EP/EX Processors up to TDP 150 Watts Overclocking



### Features:

- Max TDP 150W
- 4XΦ6mm Heatpipe Provides Faster Heat Dissipation Rate
- Design For 2U Server
- PWM Function Fan for a Silent Operation